

Data sheet

Part number : VFGV1104LS-TR



Package	PLCC-2 Type, Outer Dimension 3.5 x 2.8 x 1.9mm(L x W x H)
Product features	•Wide range temperature applicable product •High reliability (for automotive applications and other high-reliability required applications) •Lead-free soldering compatible •RoHS2 compliant

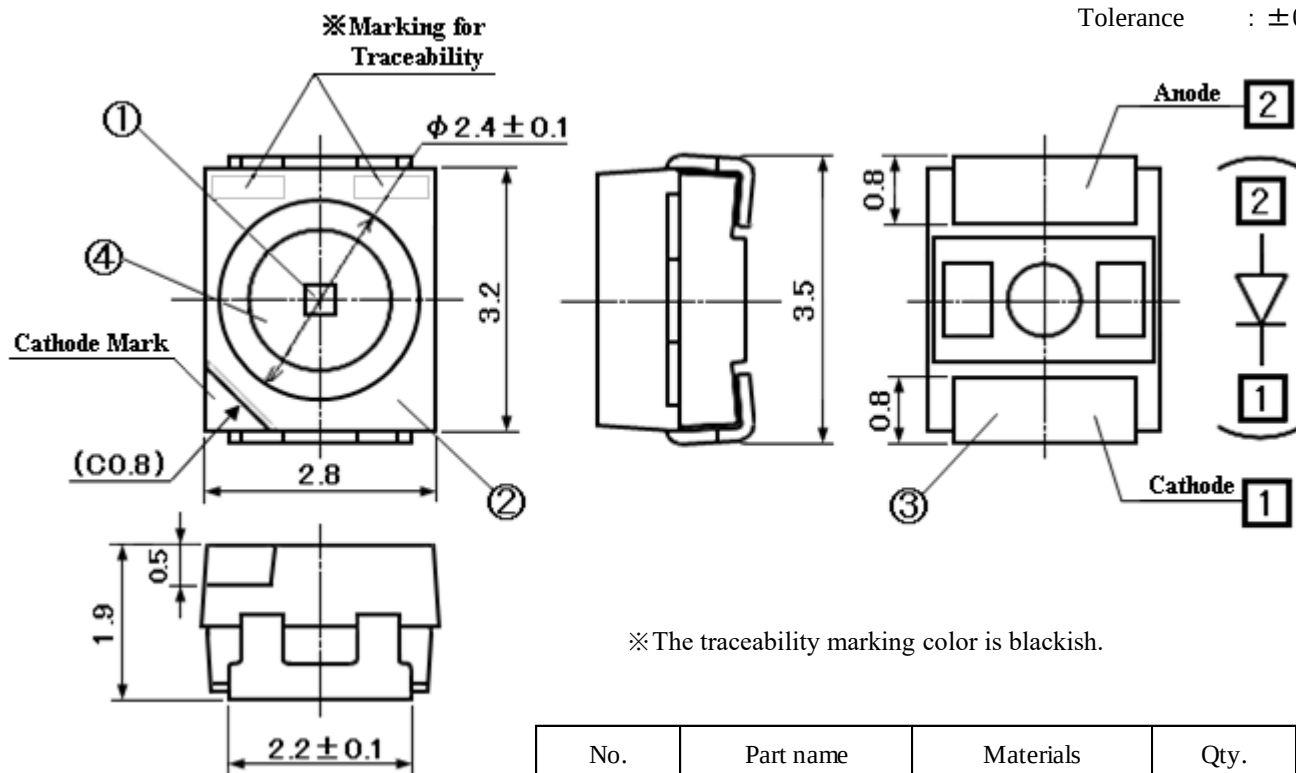
Recommended Applications

- Automotive interior: Switch and buttons , meter panel, car audio , HVAC, other various indicator etc.

Outline dimensions

VFGV1104LS-TR

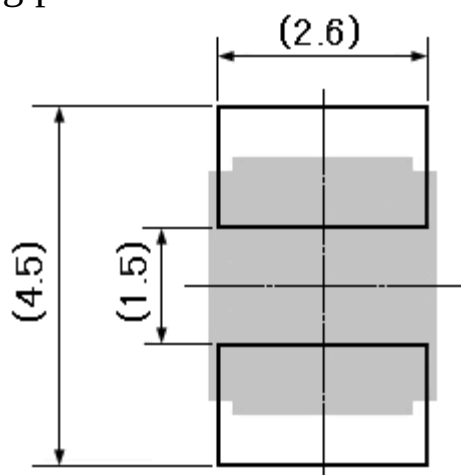
Unit : mm
Weight : 33mg
Tolerance : ± 0.2



No.	Part name	Materials	Qty.
①	LED die	AlGaInP	1
②	Lamp housing	White resin	1
③	Terminal	Au/Pd plating	2
④	Encapsulant	Silcorne resin	1

Recommended soldering pattern

Unit : mm



Specifications

VFGV1104LS-TR

【 Product Overview 】

Die Material	AlGaInP
Emitting Color	Red
Resin Color (Emitting Area)	Water Clear
Resin Color (Lamp Housing)	White

【 Absolute Maximum Ratings 】

(Ta=25°C)

ITEM	SYMBOL	MAXIMUM RATINGS	UNITS
Power Dissipation	Pd	189	mW
Forward Current	I _F	70	mA
Repetitive Peak Forward Current "10ms,1/20duty"	I _{FRM}	100	mA
I _F Derate Linearly from "75°C"	ΔI _F	1.43	mA/°C
I _{FRM} Derate Linearly from "75°C"	ΔI _{FRM}	2.04	mA/°C
Allowable Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-40 to +100	°C
Storage Temperature	T _{stg}	-40 to +120	°C
Electrostatic Discharge Threshold "HBM"	ESD	1,000	V
Soldering Temperature "Reflow Soldering"	T _{slid}	260	°C

Note1

Note2

Note 1 ESD testing method : EIAJ4701/300(304) Human Body Model(HBM) 1.5kΩ,100pF

Note 2 Please refer to page 8, Soldering conditions.

【 Thermal Characteristics 】

(Ta=25°C)

ITEM	SYMBOL	TYP.	MAX.	UNITS
Thermal Resistance 【Junction - Ambient】	R _{th(j-a)}	260	-	°C/W
Thermal Resistance 【Junction - Solder point】	R _{th(j-s)}	110	-	°C/W
Junction Temperature	T _j	-	120	°C/W

Note3

Notes3 R_{th(j-a)} Measurement Condition
Substrate:FR-4 (t=1.6mm)
Pattern Size : 16mm²

Specifications

VFGV1104LS-TR

【 Electro-Optical Characteristics 】

(Ta=25°C)

ITEM	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Forward Voltage	V_F	$I_F = 50\text{mA}$	-	2.2	2.6	V	Notes 4
Reverse Current	I_R	$V_R = 5\text{V}$	-	-	100	μA	
Luminous Intensity	I_V	$I_F = 50\text{mA}$	680	940	1,200	mcd	Notes 5
Luminous Flux	Φ_V	$I_F = 50\text{mA}$	-	2.97	-	lm	
Peak Wavelength	λ_p	$I_F = 50\text{mA}$	-	623	-	nm	
Dominant Wavelength	λ_d	$I_F = 50\text{mA}$	613	616	619	nm	Notes 6
Spectral line Half Width	$\Delta\lambda$	$I_F = 50\text{mA}$	-	20	-	nm	
Half Intensity Angle	$\Delta\theta_x$	$I_F = 50\text{mA}$	-	120	-	deg.	Notes 7
	$\Delta\theta_y$		-	120	-		

Notes 4 【Tolerance : $\pm 0.1\text{V}$ 】

Notes 5,6 Please refer to following each sorting chart.

Above the table of Luminous Intensity (I_V) values and Dominant Wavelength (λ_d) values are the setup value of the selection machine. 【Tolerance : $I_V \pm 10\%$ 、 $\lambda_d \pm 1\text{nm}$ 】

Notes 7 Viewing Angle at 50% I_V , $\Delta\theta_x$; Housing long side axis, $\Delta\theta_y$; Housing short side axis

【 Sorting Chart for Luminous Intensity and Dominant Wavelength 】

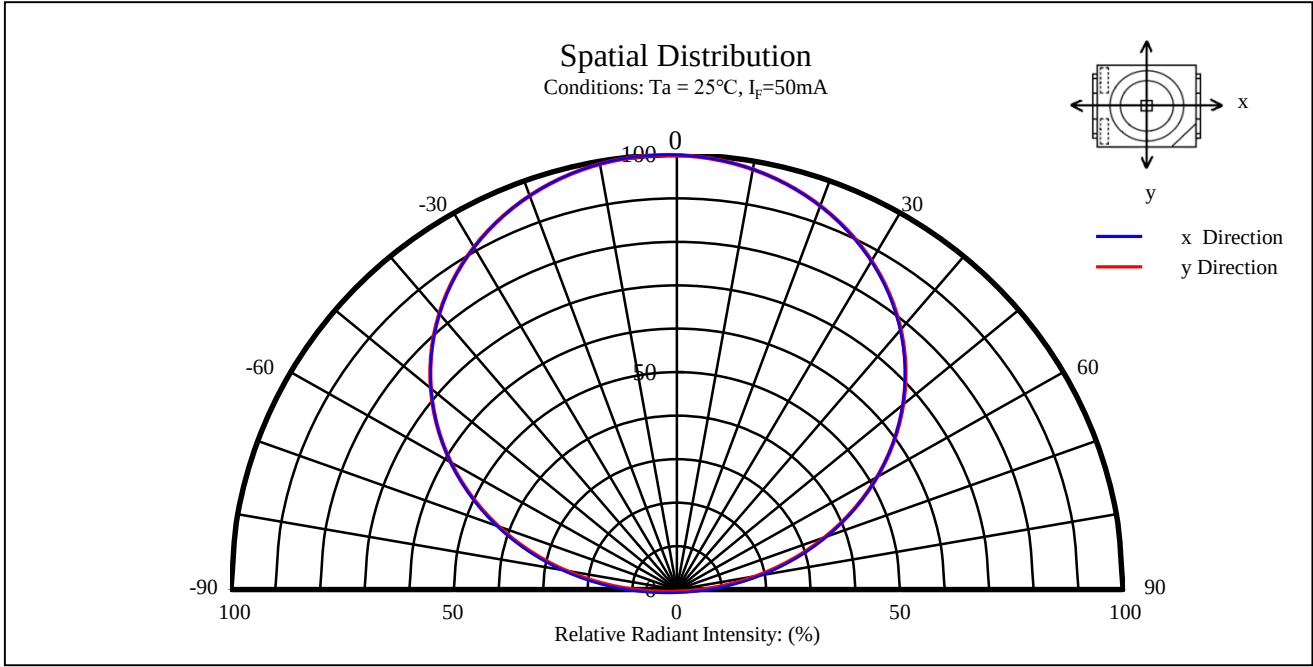
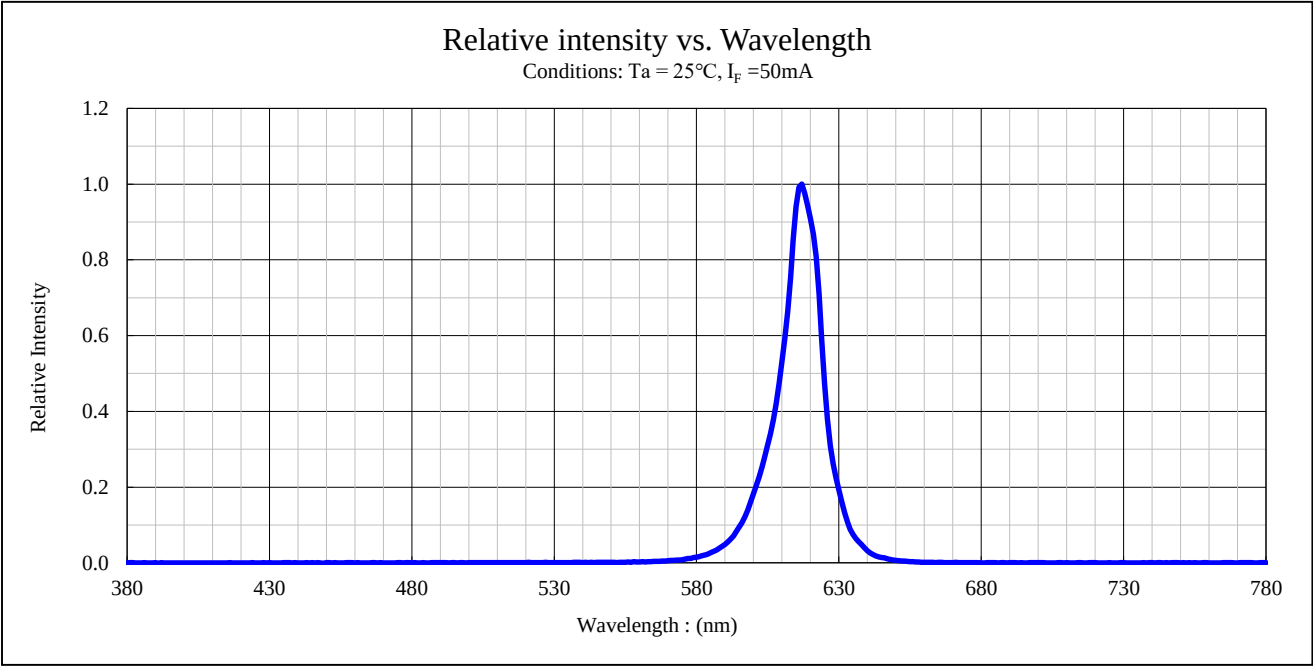
LED's shall be sorted out into the following ranks of Luminous Intensity and Dominant Wavelength.

Luminous Intensity (I_V) Rank				Dominant Wavelength (λ_d) Rank			
Rank	Luminous Intensity $I_V(\text{mcd})$		Conditions	Rank	Dominant Wavelength $\lambda_d(\text{nm})$		Conditions
	MIN.	MAX.			MIN.	MAX.	
CY	680	820	$T_a=25^\circ\text{C}$, $I_F=50\text{mA}$	B	613	616	$T_a=25^\circ\text{C}$, $I_F=50\text{mA}$
CZ	820	1,000		C	616	619	
D1	1,000	1,200					

Above the table of Luminous Intensity (I_V) values and Dominant Wavelength (λ_d) values are the setup value of the selection machine. 【Tolerance : $I_V \pm 10\%$ 、 $\lambda_d \pm 1\text{nm}$ 】

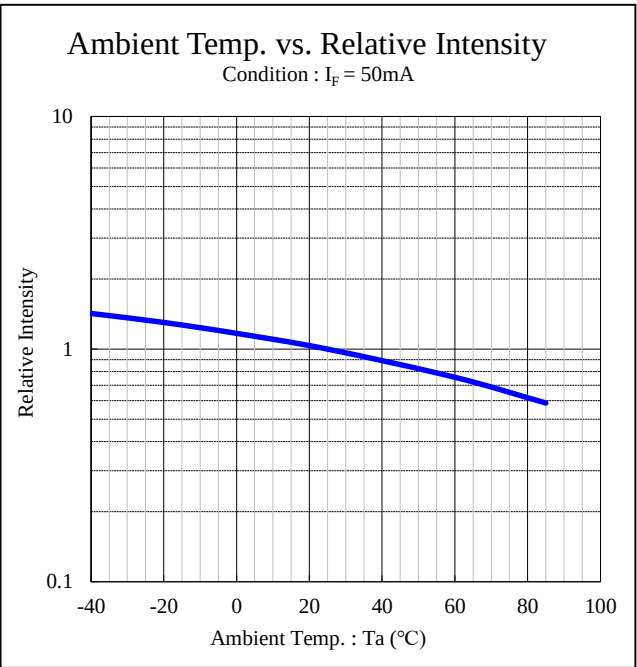
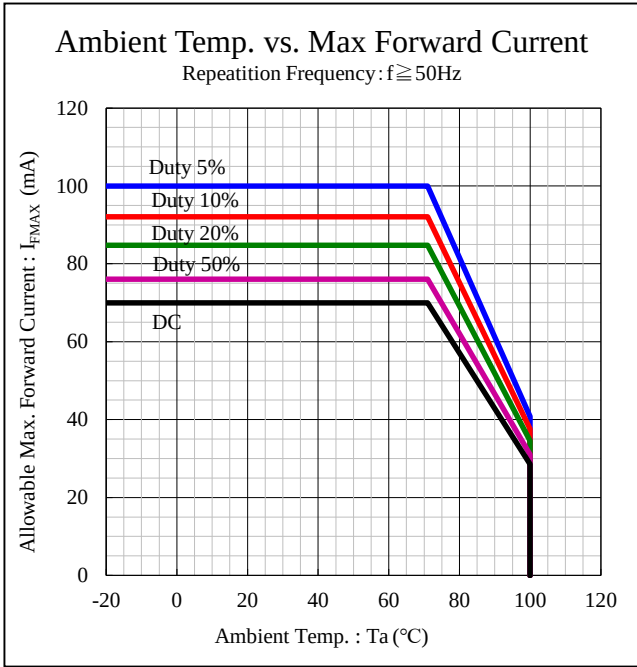
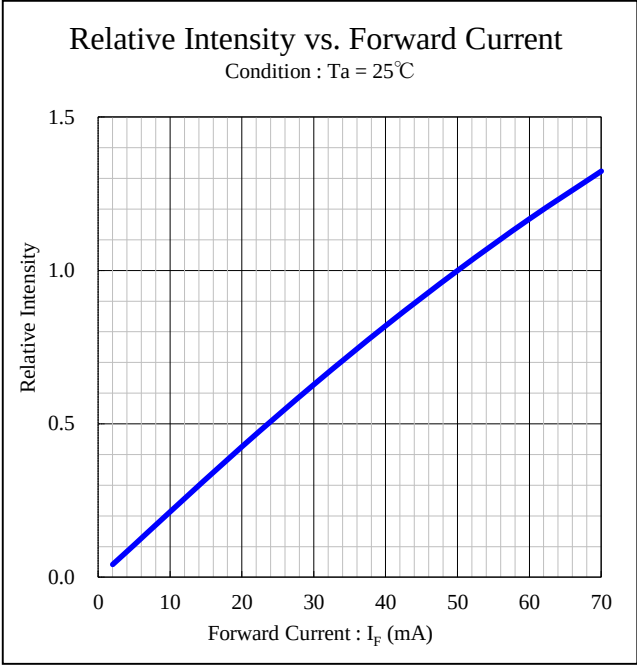
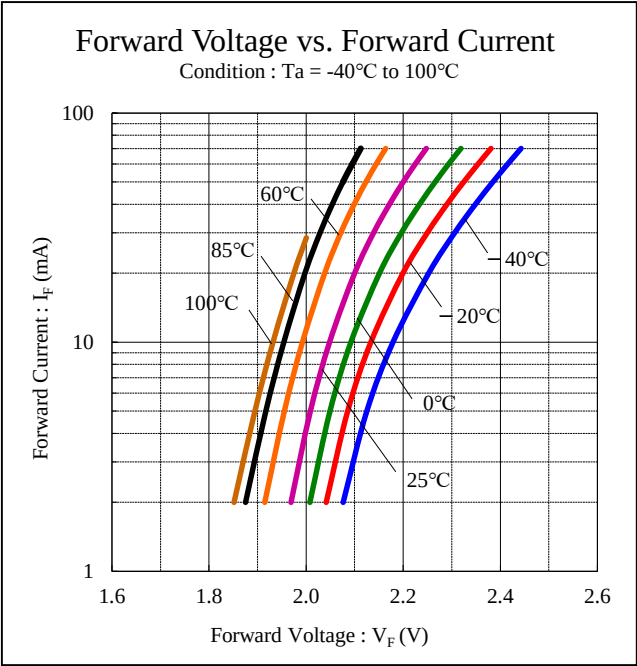
Technical Data

VFGV1104LS-TR



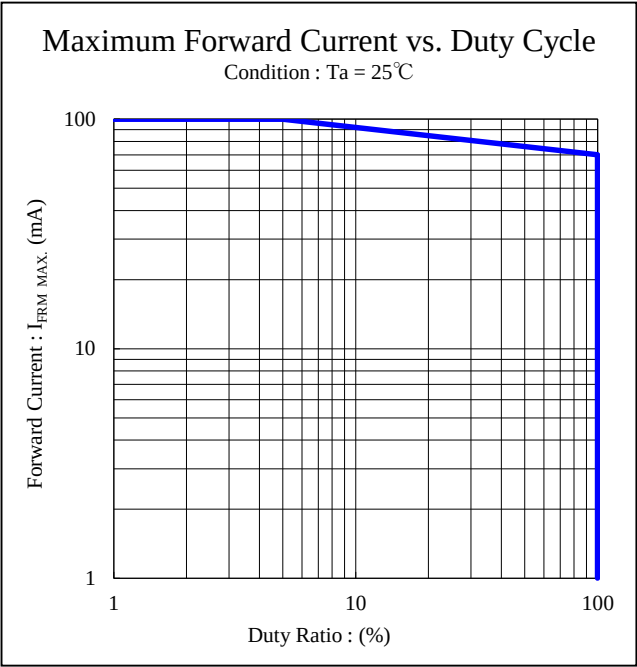
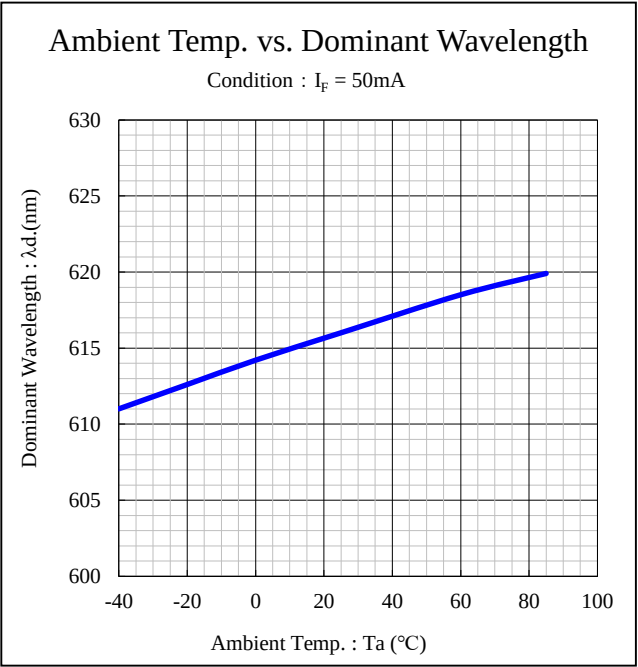
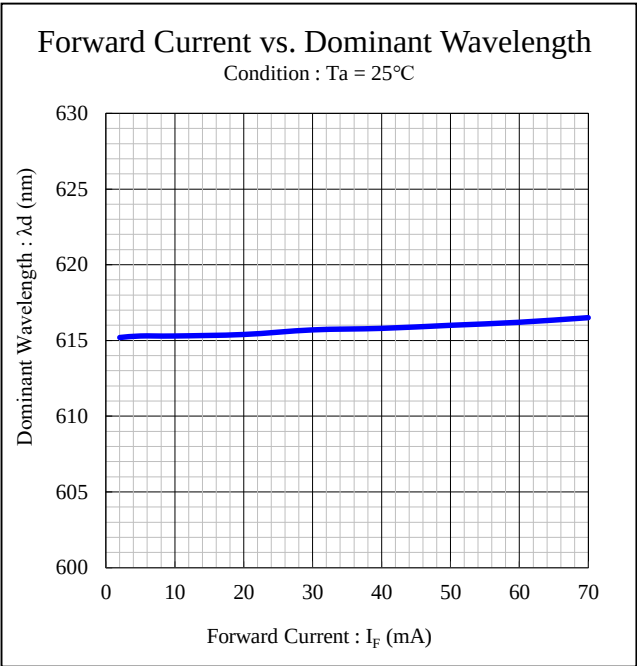
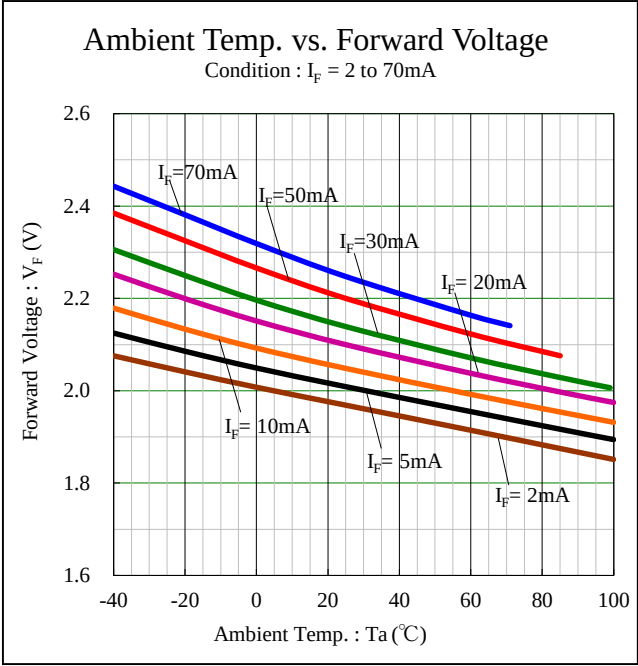
Technical Data

VFGV1104LS-TR



Technical Data

VFGV1104LS-TR



Soldering condition

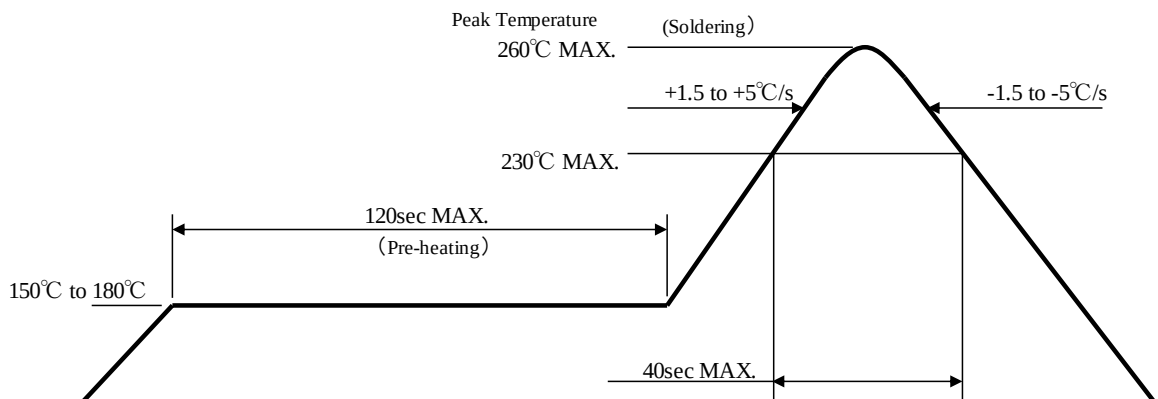
VFGV1104LS-TR

【Soldering Precaution】

(acc.to EIAJ-4701/300)

1. Heat stress during soldering will influence the reliability of LEDs, however that effect will vary on heating method. Also, if components of varying shape are soldered together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat (e.g., surface mount LED).
2. LED parts including the resin are not stable immediately after soldering (when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.
3. Recommended temperature profile for the reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density .
Please do not repeat the heating process in reflow process more than 2 times.

【Recommended Reflow Soldering Condition 】



Note 1 Temperature profile for the reflow should be set to the surface temperature of resin which is on the top of LED. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Note 2 The reflow soldering process should be done up to 2 times Max. When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of LED. The second soldering process should not be done until LEDs have returned to room temperature (by nature-cooling) after first soldering process.

Soldering condition

VFGV1104LS-TR

4. If soldering manually, Stanley recommends using a soldering iron equipped with temperature control. During the actual soldering process, make sure that the soldering iron never touch the LED itself, and avoid the LED's electrode heating temperature reaching above the heating temperature of the solder pad. All repairs must be performed only once in the same spot, and please avoid reusing components.
5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature before using. Also, please avoid applying any type of pressure to the soldered components before the solder has been cooled and hardened, as it may deteriorate solder performance and solder quality.

【Recommended Manual Soldering Condition】

Temperature of Iron Tip	350°C MAX.
Soldering Duration, Time	3sec. Max., 1 time

6. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation (UV) setting resin with heat shall be recommended.
《The curing condition, Temperature: 150°C Max./Time: 120sec. Max.》
7. Flow soldering (dip soldering) is not recommended for this product.
8. Isopropyl alcohol is recommended for cleaning. Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on. Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component before using.

Cleaning agents	Recommended / Not recommended
Isopropyl Alcohol	✓ Recommended
Trichloroethylene	x Not recommended
Chloroethene	x Not recommended
Acetone	x Not recommended
Thinner	x Not recommended

Handling precautions

VFGV1104LS-TR

【 For electrostatic discharge (ESD) 】

LED with an InGaN die is sensitive to voltage surges generated by On/Off status change and friction with synthetic materials, which may cause severe damage to the die or undermine its reliability. Damaged products may experience conditions such as extremely high reverse voltage, decrease of forward rise voltage, deterioration in optical characteristics.

Stanley InGaN products are packed with anti-static components. However, following precautions must be taken into account upon product shipment.

1. Electrification/static electricity protection

In order to avoid product (die) damage from static electricity caused by unprotected handling by operator and other charged materials coming in contact with the product, Stanley recommends taking the following precautions.

- ① Do not place electrified non-conductive materials near the LED product.
Avoid LED products from coming into contact with metallic materials.(Should the metallic material be electrified , the sudden surge voltage will most likely damage the product.)
- ② Avoid a working process which may cause the LED product to rub against other materials.
- ③ Install ground wires for any equipment, where they can be installed, with measures to avoid static electricity surges.
- ④ Prepare a ESD protective area by placing a Conductive Mattress (1MΩ MAX.) and Ionizer to remove any static electricity.
- ⑤ Operators should wear a protective wrist-strap.
- ⑥ Operators should wear conductive work-clothes and shoes.
- ⑦ To handle the products directly, Stanley recommends the use of ceramic, and not metallic, tweezers.

2. Working environment

- ① A dry environment is more likely to cause static electricity. Although a dry environment is ideal for storage state of LED products, Stanley recommends an environment with approximately 50% humidity after the soldering process.
- ② Recommended static electricity level in the working environment is less than 150V, which is the same value as Integrated Circuits (which are sensitive to static electricity).

Handling precautions

VFGV1104LS-TR

【Other Precautions】

1. Stanley LED Lamps have semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions
2. Absolute Maximum Ratings are set to prevent LED lamps from failing due to excess stress(temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.
3. In order to ensure high reliability from LED Lamps, variable factors that arise in actual usage conditions should be taken into account for designing. (Derating of TYP., MAX Forward Voltage, etc.)
4. Please insert Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
5. Please avoid the stick of foreign material because molding resin in the products have adhesiveness. Also please don't touch lens portion.
6. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
7. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
8. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
9. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health (such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
10. When there is a process of supersonic wave welding etc. after mounting the product, there is a possibility of affecting on the reliability of junction part in package (junction part of die bonding and wire bonding). Please make sure there is no problem before using.
11. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

Handling precautions

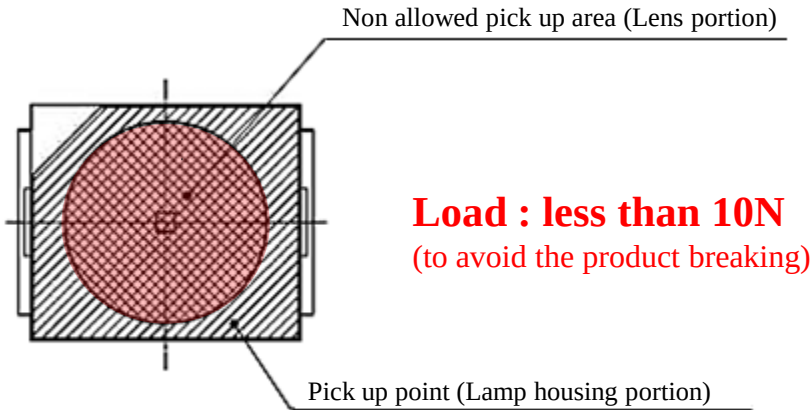
VFGV1104LS-TR

【Handling Precautions for Product Mounting】

<Recommendation>

1. Picking up point with nozzle: Lamp housing of the product ( area)
(Shown below)

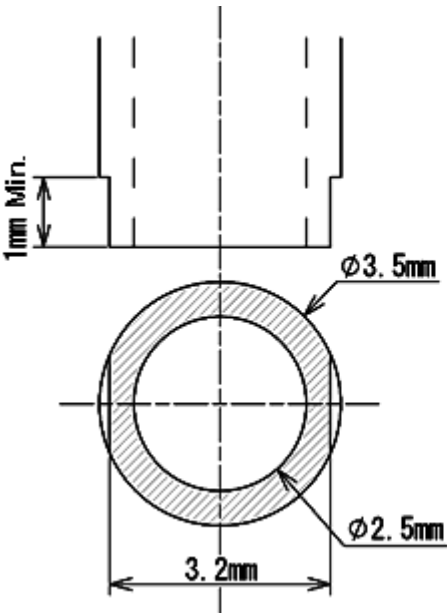
The picking up point should be within lamp housing portion, because the silicone resin used for the lens is soft.
(If the nozzle makes contact with the lens, the products might be destroyed)



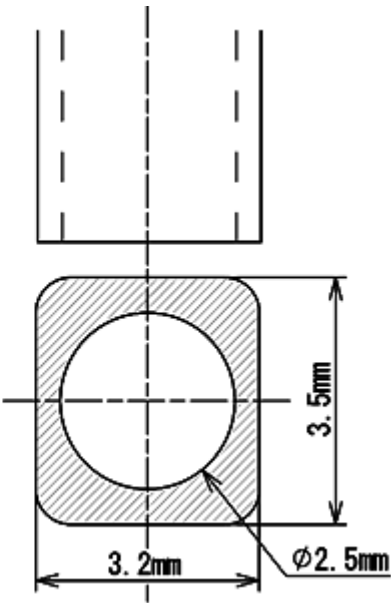
Please adjust the load, the pick up point, the nozzle diameter, etc. before mounting because the over load can cause the breakage of the lamp housing.

2. Recommended Nozzle shape

a



b



※Nozzle with chamfering is recommended

Packaging specifications

VFGV1104LS-TR

This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

【Recommended Storage Condition / Products Warranty Period】

Temperature	+5~30°C
Humidity	Under 70%

In the case of the package unopened , 6 months under 【 Recommended Storage Condition 】.
Please avoid rapid transition from low temp. condition to high temp. condition
and storage in corroding and dusty environment.

【Time elapsed after Package Opening】

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering as is **【maximum 672h】**.

If the device needs to be soldered twice, both soldering operations must be completed within 672h.

If any components should remain unused, please reseal the package and store them under the conditions described in the 【 Recommended Storage Condition 】 above.

This product must be required to perform baking process (moisture removal) **for at 48h(MIN.) to 72h(MAX.) at 60±5 degrees Celsius** if following conditions apply.

1. In the case of silica gel (blue) which indicates the moisture level within the package, changes or loses its blue color.
2. In the case of time passes for 4weeks(672h) after the package is opened once.

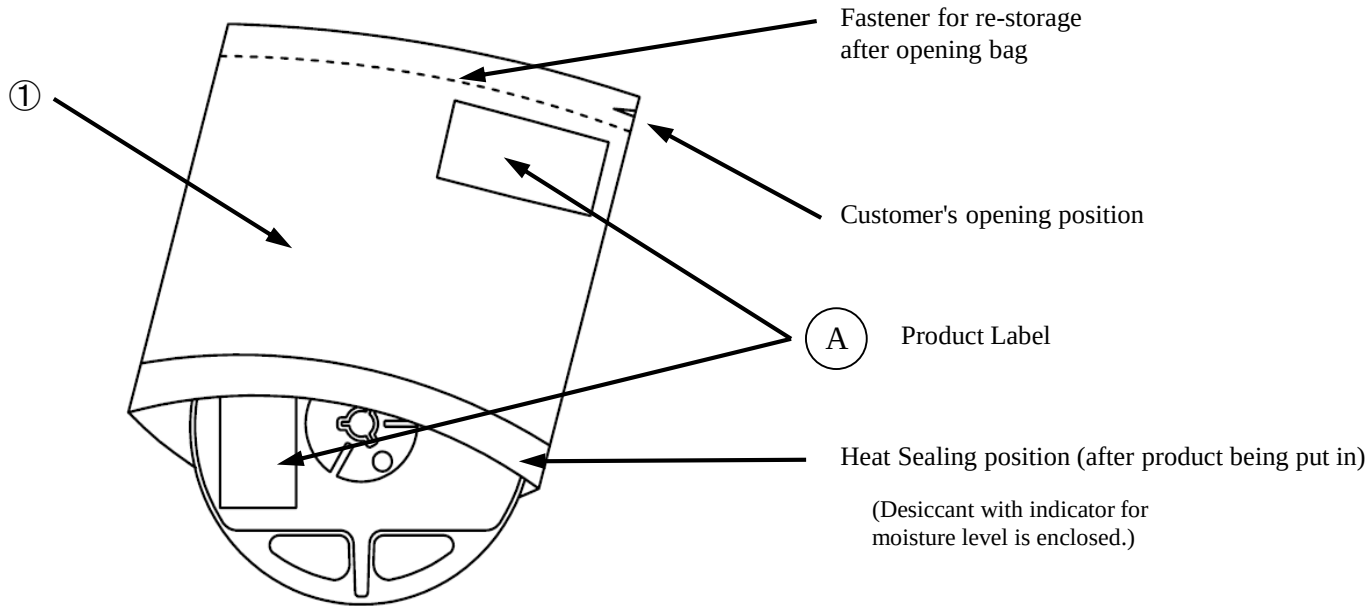
Baking process should be performed after LED having been taken out of the package.

Baking may be performed in the tape-reel form , however if it is performed with the reel stacked over one another, it may cause deformation of the reels and taping materials and later obstruct mounting. Please handle only once it has returned to room temperature. Provided that, baking process shall be 2 times MAX.

Packaging specifications

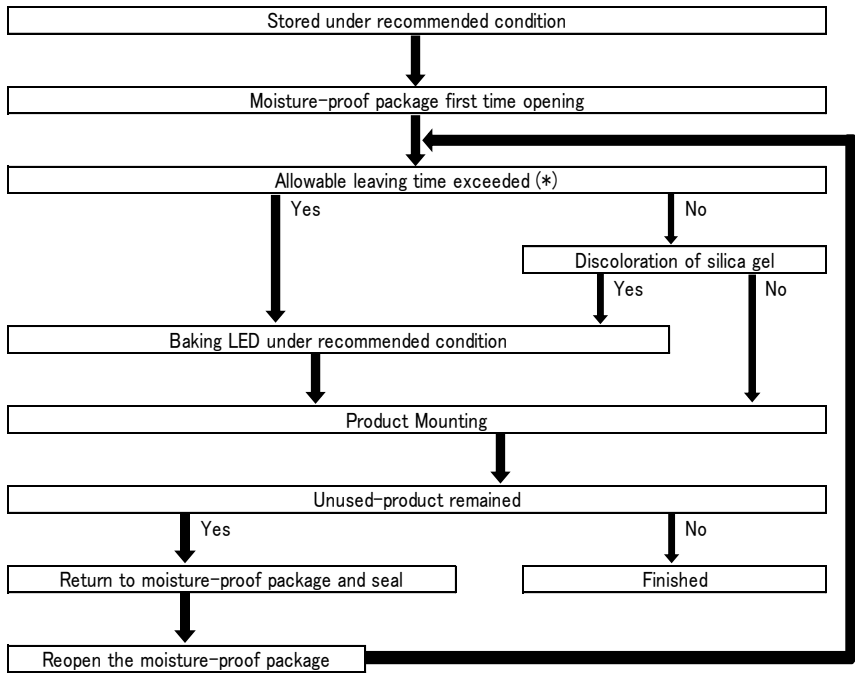
VFGV1104LS-TR

【Moisture-proof Packaging Specification】



NO.	PART NAME	MATELRIAL	REMARKS
①	Moisture-proof bag with Aluminum layer	PET+Al+PE	with ESD protection

【Flow Chart-package Opening to Mounting】



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type.

The allowable leaving time should be calculated form the first opening of package to the time when soldering process is finished.

When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated form the first opening of package, or from the time when baking process is finished.

Packaging specifications

VFGV1104LS-TR

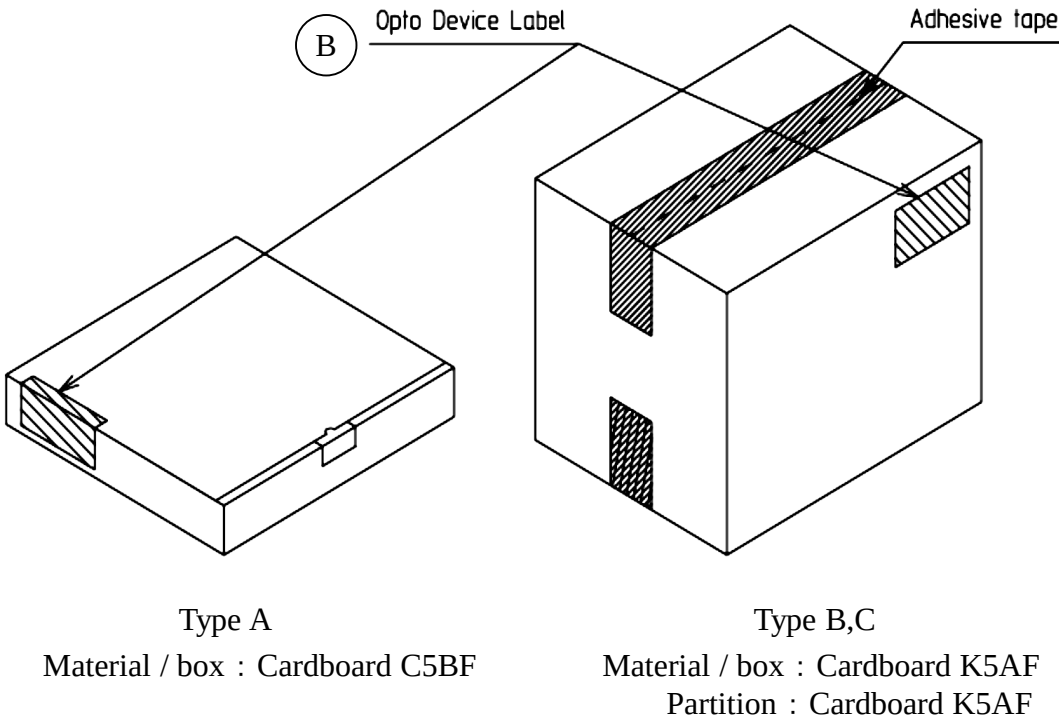
【Packing box】

(RoHS・ELV Compliant)

Box Type	Outline dimension L × W × H (mm)	Capacity of the box
Type A	280 × 265 × 45 (mm)	3 reels
Type B	310 × 235 × 265 (mm)	15 reels
Type C	440 × 310 × 265 (mm)	30 reels

The above measures are all the reference values.

The box is selected out of the above table by shipping quantity.



NO.	PART NAME	MATELRIAL	REMARKS
②	Packing Box	Corrugated Cardboard	without ESD protection

Packaging specifications

VFGV1104LS-TR

【Label Specification】

(acc.to JIS-X0503(Code-39)

A Product label

STANLEY -STANLEY ELECTRIC CO.,LTD.-

A [] B [] C [] D [] PCS E [] F [] G []

Lot No. []

- A. Parts number
- B. Bar-code for parts number
- C. Parts code (In-house identification code for each parts number)
- D. Packed parts quantity
- E. Bar-Code for packed parts quantity
- F. Lot number & Rank
(refer to Lot Number Notational System for details)
- G. Bar-Code for Lot number & Rank

B Opto device label

STANLEY OPTO DEVICES

A [] 御中 B [] C [] D [] E [] PCS F [] G [] H []

Q'TY [] C/NO []

STANLEY ELECTRIC CO.,LTD.

- A. Customer Name
- B. Parts Type
- C. Parts Code
- D. Parts Number
- E. Packed Parts Quantity
- F. Carton Number
- G. Shipping Date
- H. Bar-Code for In-house identification Number

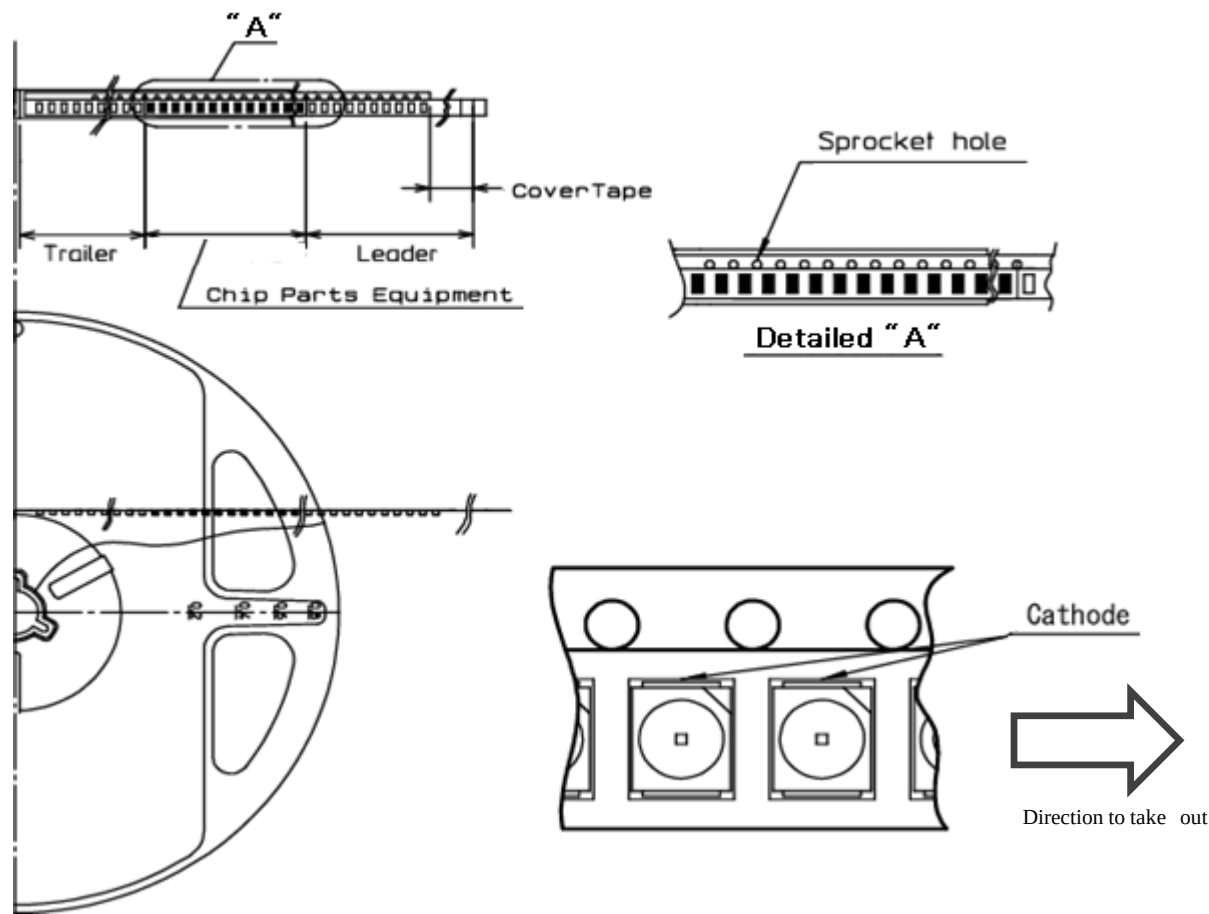
<Remarks> Bar-code font : acc.to Code-39(JIX0503)

Taping and reel specifications

VFGV1104LS-TR

(acc.to JIS-C0806-03)

【Appearance】



Note

"-TR" means cathode side of LEDs should be placed on the sprocket-hole side.

Items		Specifications	Remarks
Leader area	Cover-tape	Cover-tape shall be longer than 320mm without carrier-tape	The end of cover-tape shall be held with adhesive tape.
	Carrier-tape	Empty pocket shall be more than 20 pieces.	Please refer to the above figure for Taping & reel orientation .
Trailer area		Empty pocket shall be more than 15 pieces.	The end of taping shall be inserted into a slit of the hub.

Taping and reel specifications

VFGV1104LS-TR

(acc.to JIS-C0806-03)

【Qty. per Reel】

2,000parts/reel

Minimum Qty. per reel might be 500 parts when getting less than 2,000 parts.

In such case, parts of 500-unit-qty. shall be packed in a reel and the qty. shall be identified on the label.

【Mechanical strength】

Cover-tape adhesive strength shall be 0.1~1.0N (An angle between carrier-tape and cover-tape shall be170 deg.)

Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

【Others】

Reversed-orientation, Up-side down placing, side placing and out of spec. parts mixing shall not be held.

Max. qty. of empty pocket per reel shall be defined as follows.

Qty./reel	Max. qty. of empty pocket	Remark
500	1	-
1,000	1	-
1,500	1	-
2,000	2	No continuance

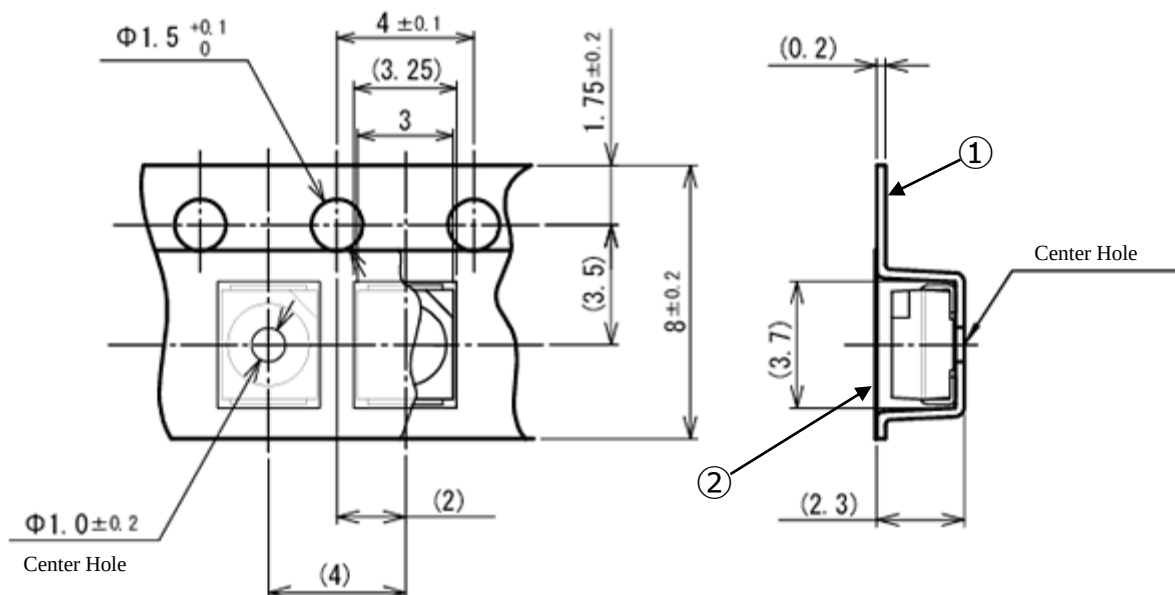
Taping and reel specifications

VFGV1104LS-TR

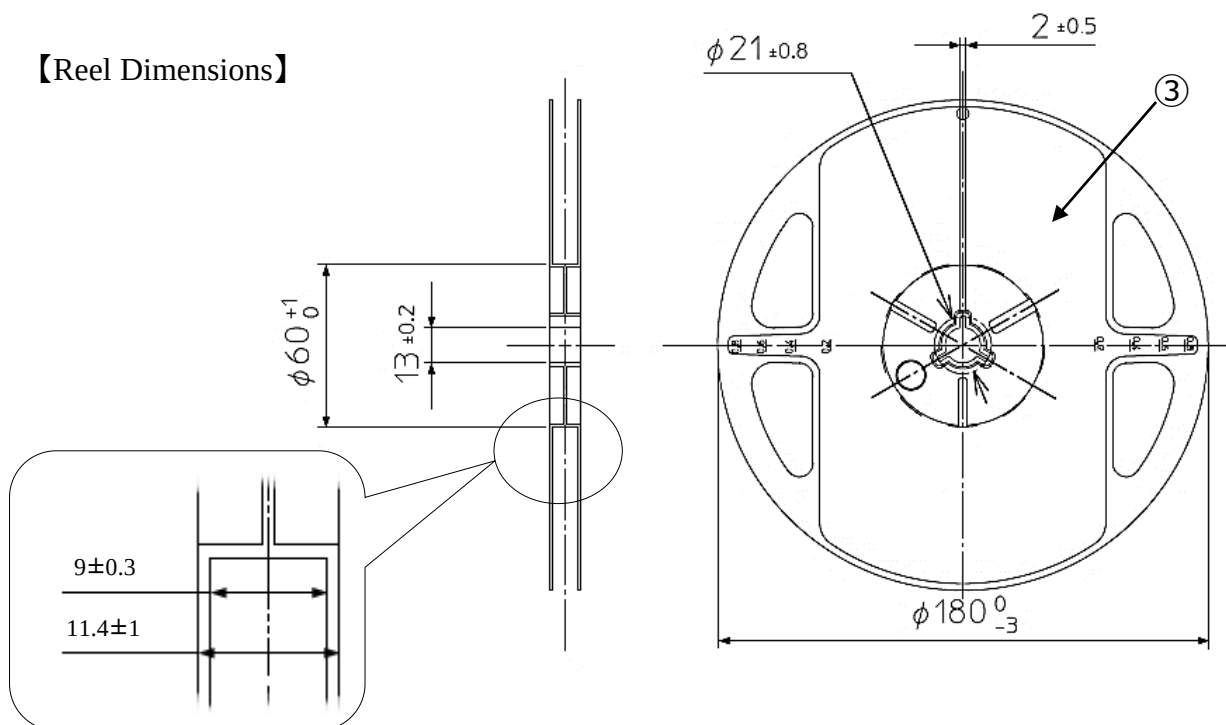
(acc.to JIS-C0806-03)

Unit : mm

【Taping Dimensions】



【Reel Dimensions】



NO.	PART NAME	REMARKS
①	Carrier-tape	with ESD protection
②	Cover-tape	with ESD protection
③	Carrier-reel	with ESD protection

Lot number notational system

VFGV1104LS-TR

①	②	③	④	⑤	⑥	⑦	⑧	⑨							

① - 1digit : Production location (mark identify alphabet)

② - 1digit : Production year (The last digit of production year 2024→4, 2025→5, 2026→6, 2027→7 ...)

③ - 2digits : Production month (Jan. to Sep. , should be 01,02,03 ...)

④ - 2digits : Production date

⑤ - 3digits : Serial number

⑥ - 2digits : Tape and reel following number

⑦ - 2digits : Total power rank.

(If total power rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified rank, "- -" is used to indicate.)

⑧ - 2digits : Wavelength rank

(If wavelength rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified rank, "- -" is used to indicate.)

⑨ - 1digit : VF Rank (If rank is not defined, "-" is described.)

Compliance with RoHS2/ELV

VFGV1104LS-TR

This product is in compliance with RoHS2 / ELV.

Prohibition substance and it's criteria value of RoHS2 / ELV are as follows.

- RoHS2 instruction ... Refer to following 1 to 10.
- ELV instruction ... Refer to following 1 to 4.

No.	Substances	Threshold
1	Lead and its compounds	0.1% (1,000ppm)
2	Mercury and its compounds	0.1% (1,000ppm)
3	Cadmium and its compounds	0.01% (100ppm)
4	Hexavalent chromium compounds	0.1% (1,000ppm)
5	PBB : Polybrominated Biphenyls	0.1% (1,000ppm)
6	PBDE : Polybrominated Biphenyl Ethers	0.1% (1,000ppm)
7	DEHP : Bis (2-ethylhexyl) phthalate	0.1% (1,000ppm)
8	BBP : Butyl benzyl phthalate	0.1% (1,000ppm)
9	DBP : Dibutyl phthalate	0.1% (1,000ppm)
10	DIBP : Diisobutyl phthalate	0.1% (1,000ppm)

Reliability Testing Result

VFGV1104LS-TR

1. Reliability testing result

Test Item	Reference Standard	Test Condition		Failure
Room Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=25°C I _F =70mA	1,000h	0 / 20
High Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=85°C I _F =50mA	1,000h	0 / 20
Low Temperature Operating Life	EIAJ ED-4701/100(101)	Ta=-40°C I _F =70mA	1,000h	0 / 20
Wet High Temperature Operating Life	EIAJ ED-4701/100(102)	Ta=60°C 90% I _F =70mA	1,000h	0 / 20
High Temperature Storage Life	EIAJ ED-4701/200(201)	Ta=120°C	1,000h	0 / 20
Low Temperature Storage Life	EIAJ ED-4701/200(202)	Ta=-40°C	1,000h	0 / 20
Wet High Temperature Storage Life	EIAJ ED-4701/100(101)	Ta=60°C Rh=90%	1,000h	0 / 20
Thermal Shock	EIAJ ED-4701/100(105)	Ta=-40°C to 120°C (each 15min)	1,000cycles	0 / 20
Thermal Shock Operating	EIAJ ED-4701/100(105)	Ta=-40°C(OFF) to 85°C(I _F =50mA ON) (each 15min)	1,000cycles	0 / 20
Cycled Temperature Humidity Operating Life	EIAJ ED-4701/200(203)	Ta=-30°C (2h) ~ 80°C 95% (2h) 8h / cycle I _F =57mA 5min on-off	30 cycles	0 / 20
Resistance to Reflow Soldering	EIAJ ED-4701/300(301)	Moisture Soak : 30°C 70% 4weeks(672h) Preheating : 150~180°C 90-120sec Soldering : 260°C peak	2 times	0 / 20
Electrostatic Discharge (ESD) ※	EIAJ ED-4701/300(304)	C=100pF R2=1.5kΩ ±2,000V	Once of each polarity	0 / 10
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G) 100~2,000Hz 20min XYZ direction	2h of each direction	0 / 10

※Reference Test

2. Failure criteria

Item	Symbol	Condition	Failure Criteria
Luminous Intensity	I _V	I _F =50mA	Testing Min. Value < Standard Min. Value × 0.5
Forward Voltage	V _F	I _F =50mA	Testing Max. Value ≥ Standard Max. Value × 1.2
Cosmetic Appearance	-	-	Notable discoloration, deformation and cracking

Special Notice to Customers Using the Products and Technical Information Shown in This Data Sheet

- 1) The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.
- 2) For the purpose of product improvement, the specifications, characteristics and technical data described in the data sheets are subject to change without prior notice. Therefore it is recommended that the most updated specifications be used in your design.
- 3) When using the products described in the data sheets, please adhere to the maximum ratings for operating voltage, heat dissipation characteristics, and other precautions for use. We are not responsible for any damage which may occur if these specifications are exceeded.
- 4) The products that have been described to this catalog are manufactured so that they will be used for the electrical instrument of the benchmark (OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument).
The application of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. needs a high reliability and safety, and the breakdown and the wrong operation might influence the life or the human body. Please consult us beforehand if you plan to use our product for the usages of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. except OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument.
- 5) In order to export the products or technologies described in this data sheet which are under the “Foreign Exchange and Foreign Trade Control Law,” it is necessary to first obtain an export permit from the Japanese government.
- 6) No part of this data sheet may be reprinted or reproduced without prior written permission from Stanley Electric Co., Ltd.
- 7) The most updated edition of this data sheet can be obtained from the address below:
<http://www.stanley-components.com/en/>